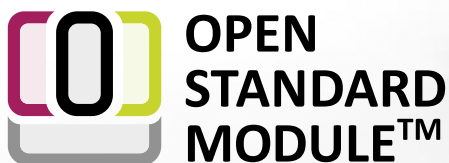
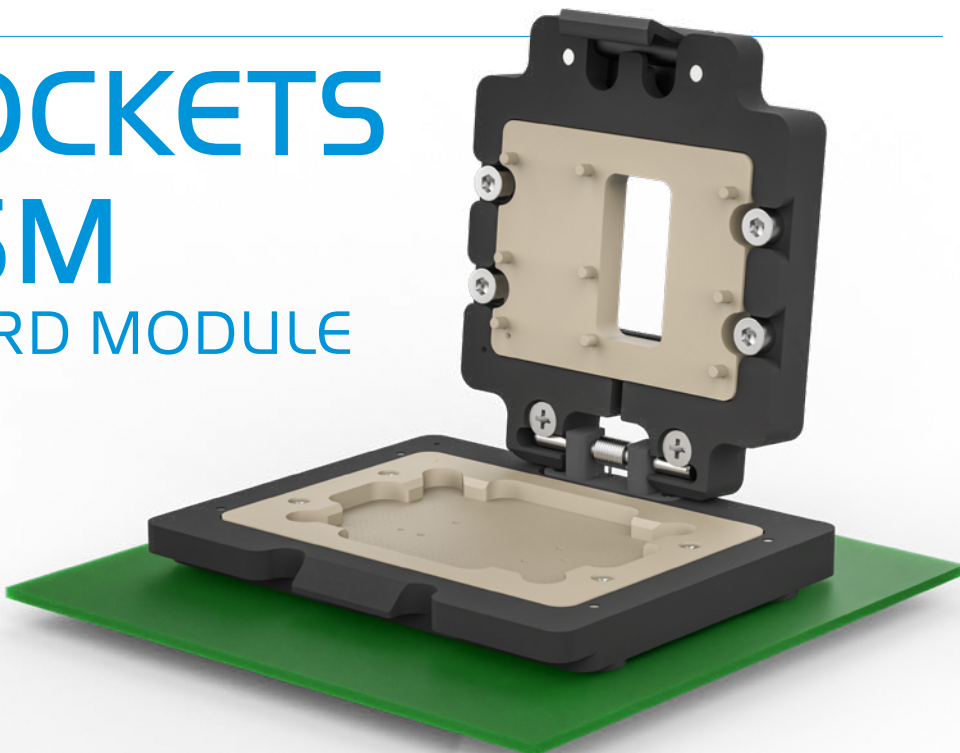


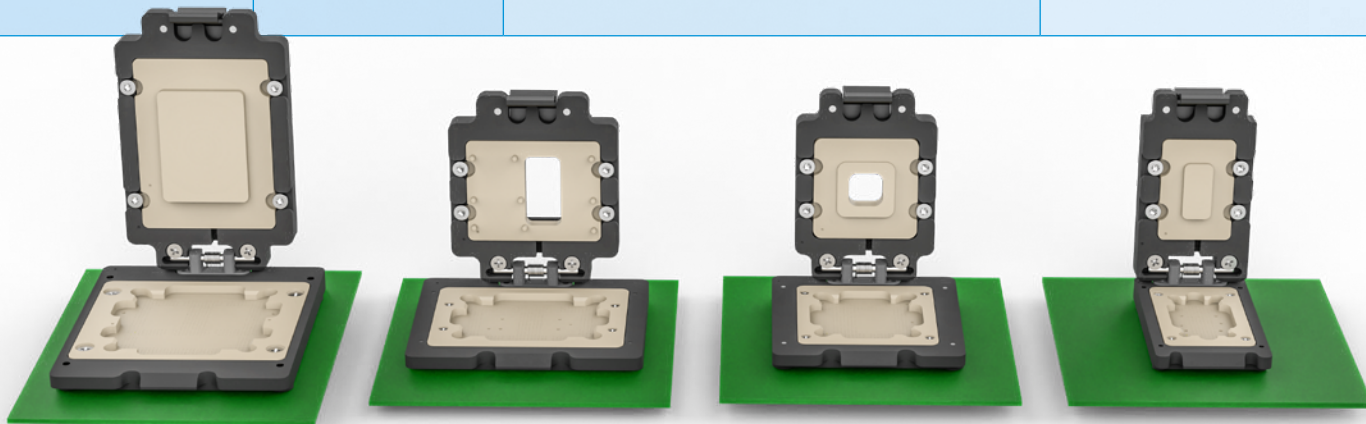
TEST SOCKETS FOR OSM

OPEN STANDARD MODULE



With the OSM™ Test Socket product group, Yamaichi Electronics offers the complete range for all module sizes 0, S, M and L. By using fine-pitch spring loaded pins – as known from semiconductor testing – all types of module interfaces can be contacted: balls, pads or bumps. The OSM™ Test Sockets are designed to decrease test costs by combining reliable testing and modular design.

Size 0	188 Pins	Compression Mount Socket requires gold pad on test PCB Standard contact pin is usable for LGA, BGA and bumps on module Other pin types for high volume testing are available	Individual spring loaded pushers Optimized socket sizes Ease of servicing
Size S	332 Pins		
Size M	476 Pins		
Size L	662 Pins		

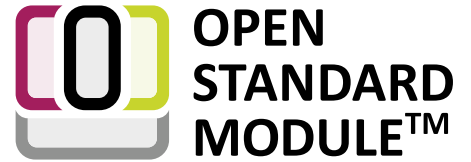


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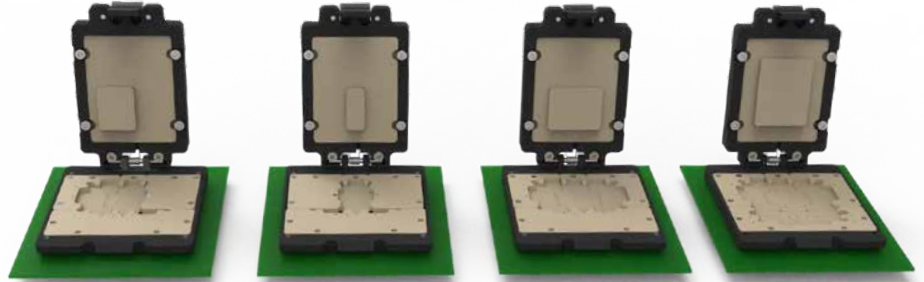
TEST SOCKETS

OSM



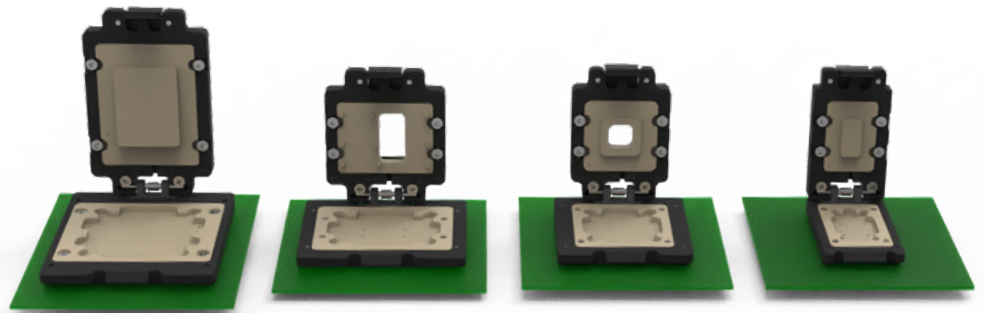
Y-IS OSM TEST SOCKET - MODULAR INSERTS

- Single socket size with optional inserts for module size 0, S, M, L
- Flexible engineering/lab socket
- Low volume test socket



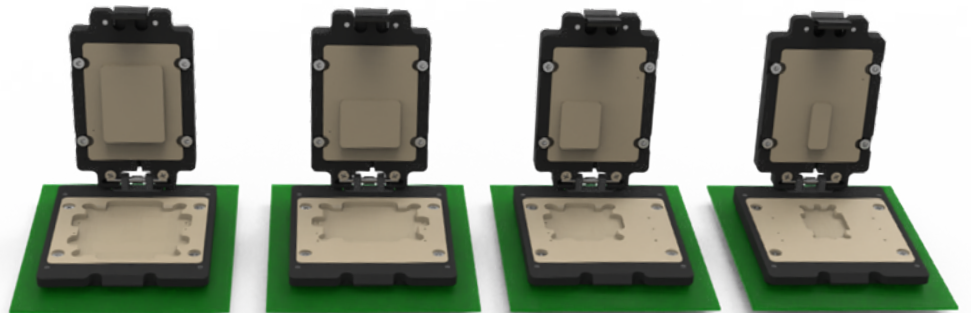
Y-IS OSM TEST SOCKET - INDIVIDUAL SIZE

- Individual socket size for module sizes 0, S, M, L
- Space saving socket
- High volume test socket



Y-IS OSM TEST SOCKET - SINGLE SIZE

- One socket size for module sizes 0, S, M, L
- Available PCB can be re-used
- Mid volume test socket



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